

# FAZIA: prototyping a next-generation $4\pi$ detection array for reaction dynamics studies with RNBs

## Contents:

- Heavy-ion reactions with **RNB** around **Fermi energy** as a probe of the isospin dependence of the nuclear EoS (e.g. **Symmetry Energy**)
- **Very demanding detectors are needed, in terms of A, Z identification, ToF and Energy measurements with improved transportability**

## FAZIA R&D: testing and applying novel solutions

- **Charge + Current preamplifiers + Fast Analogue Pipeline**
- **Fully digital electronics for Energy, Pulse Shape Analysis and Timing**
- **Si-Si-CsI *non-standard* telescope**

## FAZIA Organization and Phases

**State-of-the-art dynamical simulations applied to heavy-ion collisions with exotic isospin contents** produce observables sensitive to the symmetry energy and to its dependence on density and surface effects

(see for instance Ono et al - PRC 70 (2004), V.Baran et al – Phys.Rep. 410 (2005))

A “paradigmatic” observable: **the isotopic ratio  $R_{21}$**

For homogeneously selected events of a given pair of reactions  $r_1$ -- $r_2$ , characterized by “different isospin contents” (e.g.  $^{124}\text{Sn} + ^{64}\text{Ni} \rightarrow ^{112}\text{Sn} + ^{58}\text{Ni}$ ),  **$R_{21}$**  is the ratio of the experimental (or simulated) yields  **$Y_{2,1}(N,Z)$**  of a given isotope in the two reactions:

$$R_{21}(N,Z) = Y_2(N,Z) / Y_1(N,Z)$$

Under somewhat general (though still debated...) assumptions

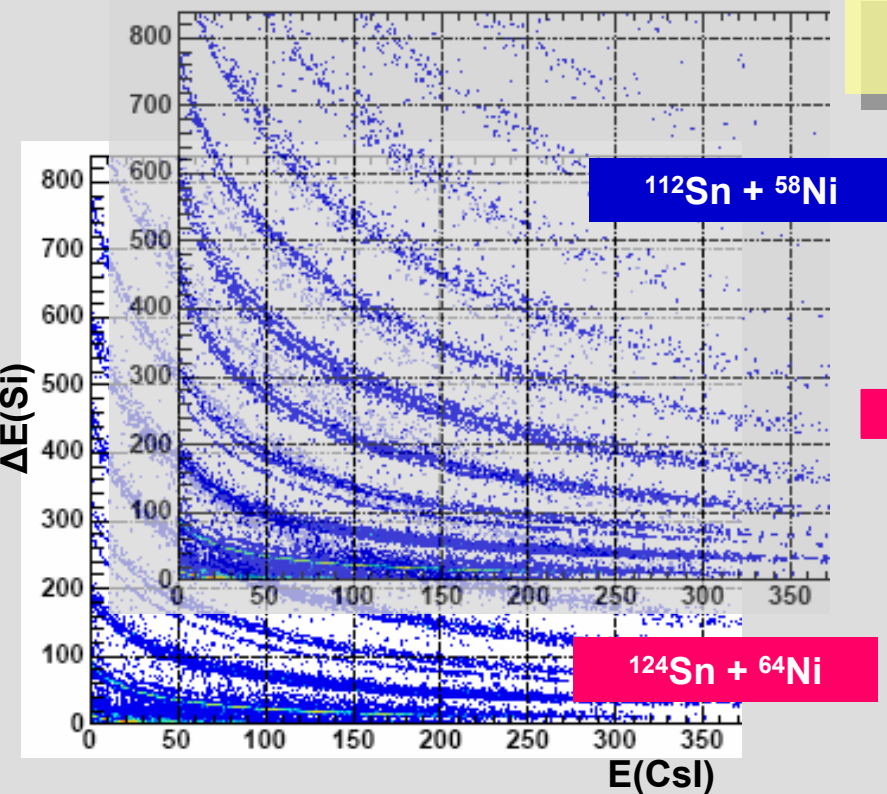
$$R_{21}(N,Z) \sim C_{\text{sym}} / T$$

with  **$T$** , temperature of the selected emitting system

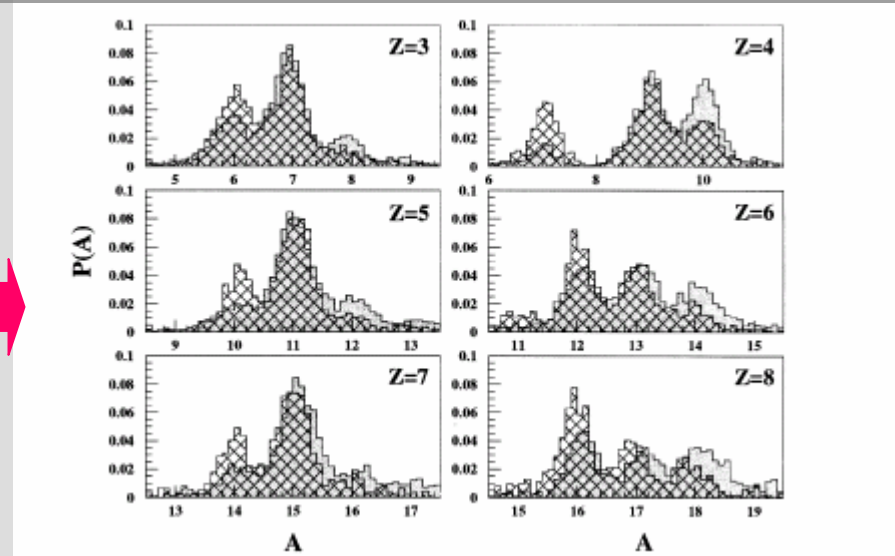
The more exotic the system, the better the sensitivity for the symmetry energy determination

*The temperature  **$T$**  can also be extracted from the various isotope yields*

How is  $R_{21}$  extracted? An example: (Le Neindre et al (CHIMERA)– NIMA 490 (2002) 251)



Shaded and hatched areas refer to two different reactions:  $^{124}\text{Sn} + ^{64}\text{Ni}$  and  $^{112}\text{Sn} + ^{58}\text{Ni}$  respectively



$$R_{21} = Y_2(N,Z) / Y_1(N,Z) \sim C_{\text{sym}} / T$$

Other important features (usually lacking in 4 $\pi$  arrays):

- Very high granularity for nuclear interferometry (disentangle between primary and secondary fragments)
- Reduced material (or easily removable) for possible insertion of neutron detectors

An updated overview of the best performing H.I. arrays (INDRA, CHIMERA, HiRA) is available here:

[http://cyclotron.tamu.edu/wci3/newer/chapVI\\_1.pdf](http://cyclotron.tamu.edu/wci3/newer/chapVI_1.pdf)

None of these detectors matches all the requirements needed for a long term Physics program aimed at determining the nEoS with RNBs

## **The FAZIA (Four Pi Z and A Identification Array)**

**initiative** (*about 70 physicists from France, Italy, Poland, Spain, Rumania, Canada, India and USA*) was formalized to define a Physics program aimed at studying the dynamics and thermodynamics (nEoS) of H.I. reactions around *Fermi energies* with RNBs.

A first R&D phase dedicated to studying new solutions for:

- *Increasing the dynamic ranges of E, Z and A identification, keeping the ToF capability*
- *Designing a transportable heavy-ion detector array: various beam energies, necessary operation at various RNB facilities*
- *Aiming at a detector as versatile, thin and compact as possible: integration with other specialized detectors (e.g. interferometers, spectrometers), possibility of detecting neutrons*

Most of the “FAZIANS” ripened their expertise in the *AZ4 $\pi$  Franco-Italian initiative*

# FAZIA: PROTOTYPING A NEXT-GENERATION 4 $\pi$ DETECTION ARRAY

## The prototype under study

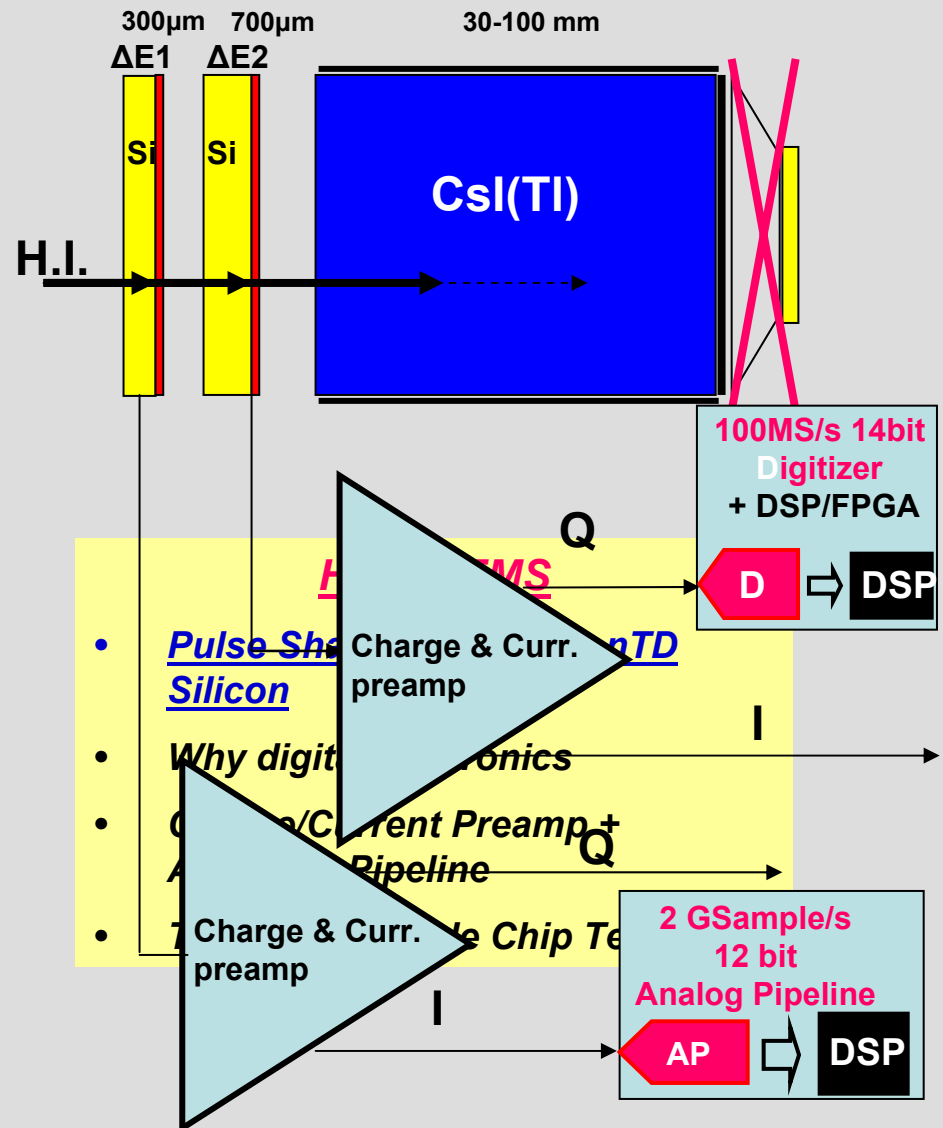
### Detector and front end electronics:

#### Three stage $\Delta E$ - $\Delta E$ -E (Si-Si-CsI telescope)

- Pulse Shape Analysis in the first reverse-mount *nTD* Silicon detector to extract Z and A with low thresholds, also exploiting ToF
- a Silicon pair of 300 $\mu\text{m}$  + 500-700  $\mu\text{m}$  for high-resolution standard A and Z identification
- a few cm thick CsI(Tl) for stopping more penetrating particles
- with a possible novel solution for the second  $\Delta E$ -E stage
- Charge-and-Current preamplifier (PACI) for improving pulse shape analysis

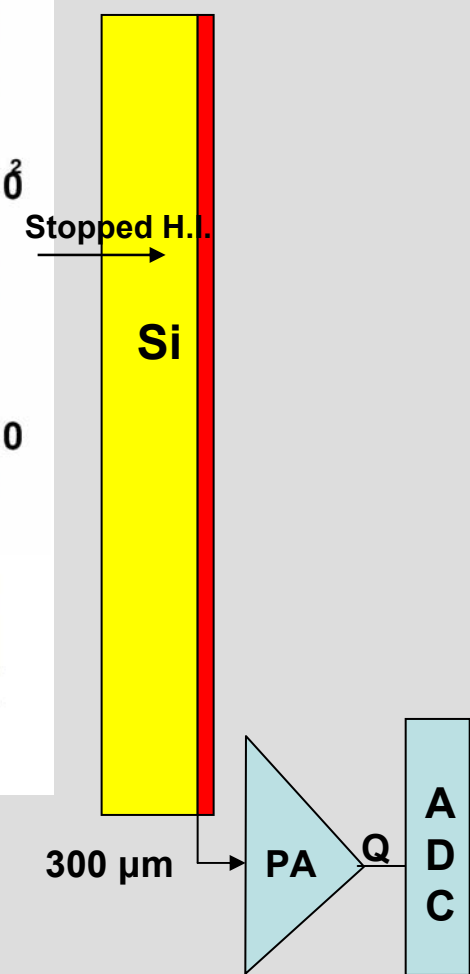
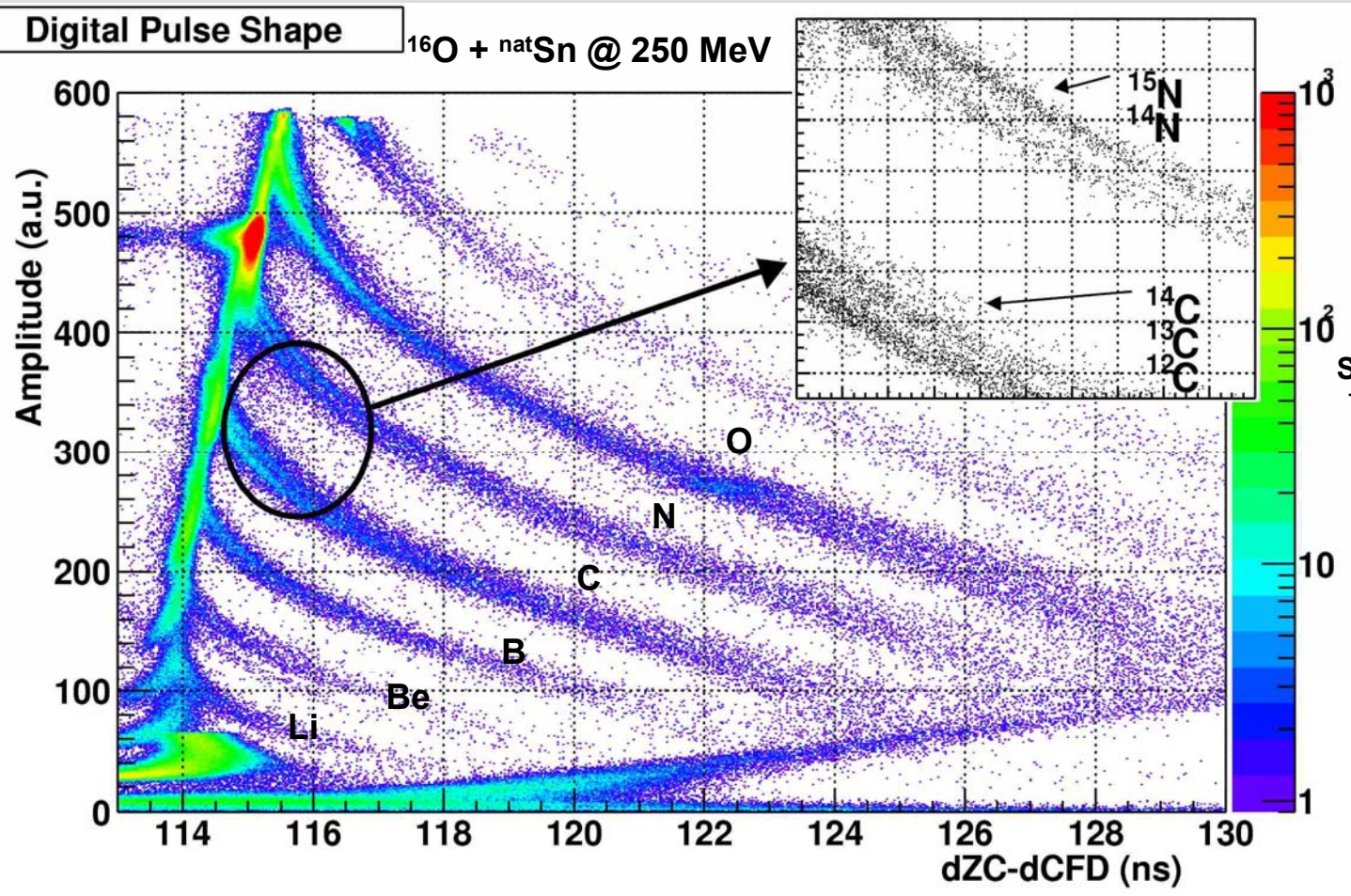
### Back-end electronics:

- Fully Digital Electronics for on-line signal treatment



# Digital Pulse Shape analysis of *charge signal*. Particle identification of particles stopped in a “reverse mounted” Silicon detector.

*L. Bardelli et al: NP A746 (2004) 272*



Thresholds are around 2 AMeV for Z=6. Present upper limit is around  $Z \cong 20$ . How far can we go?

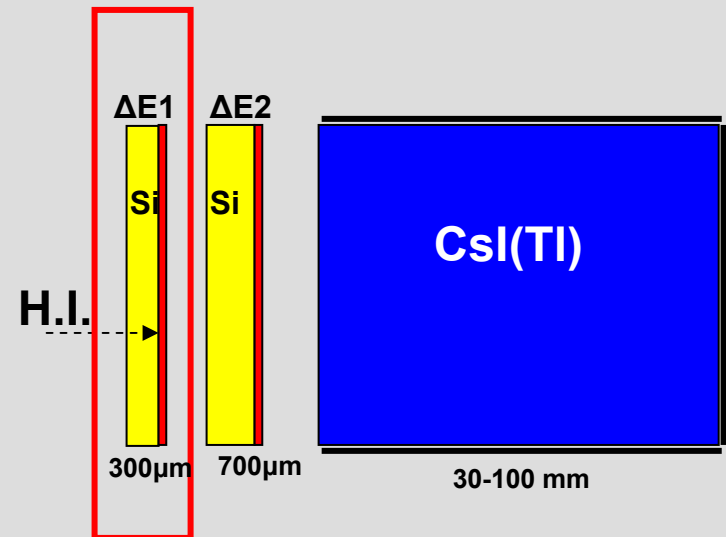
Pulse Shape Analysis in Silicon

**Pulse Shape Analysis of particles stopped in nTD Silicon:** a promising approach to significantly lower the energy for Z (and A?) identification capability  $\rightarrow$  see *E vs risetime*.

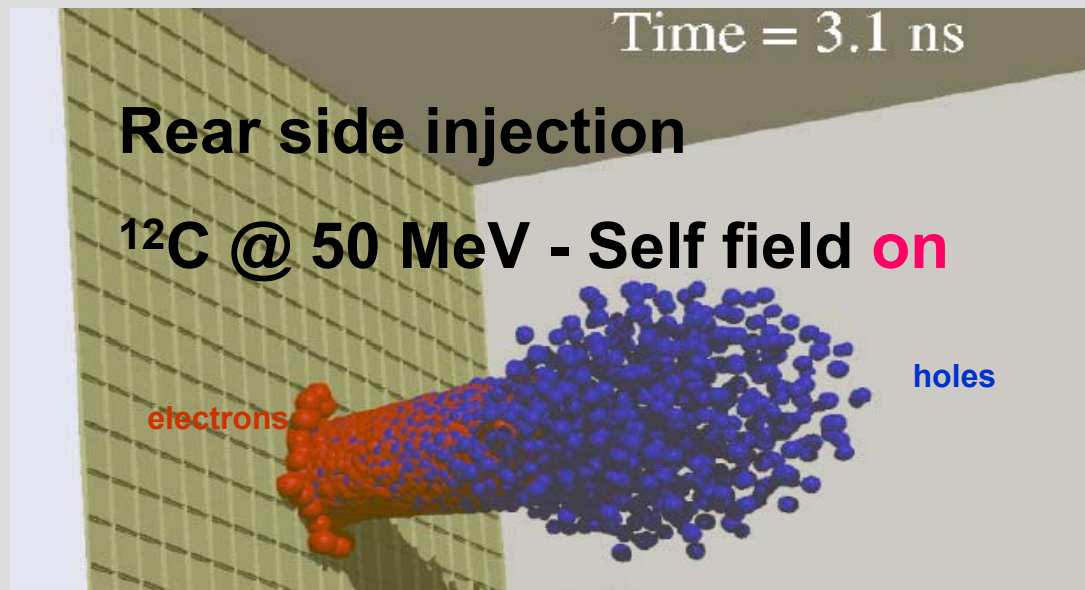
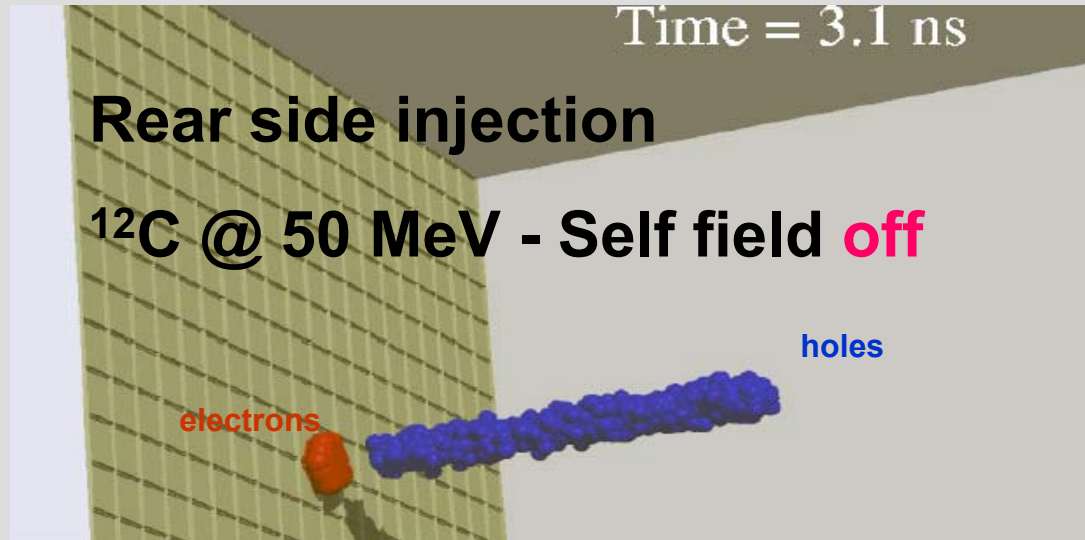
In order to improve discrimination algorithms is necessary to *understand the Physics of the “plasma delay” process*.

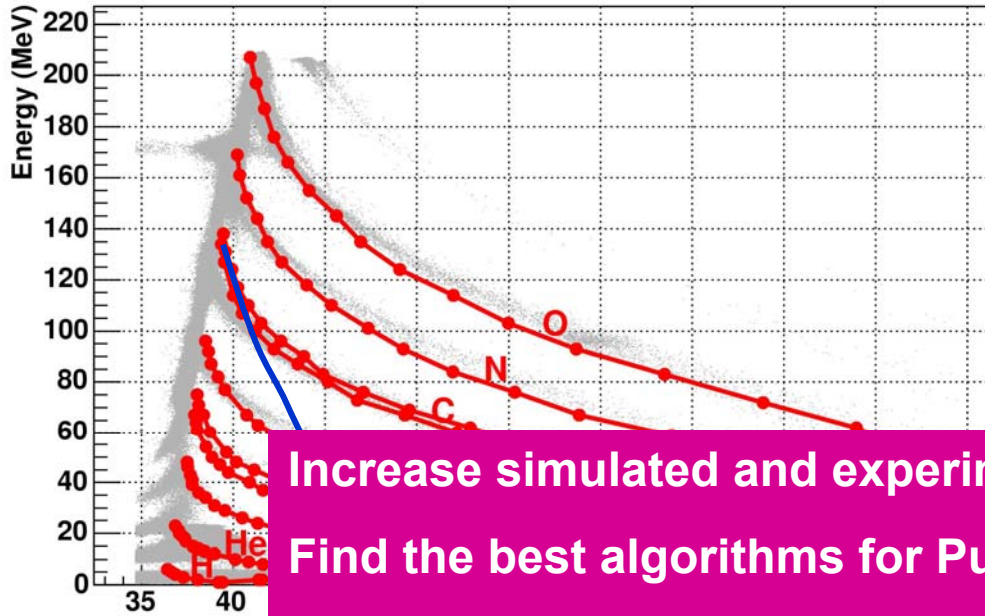
*A first-principles approach to “plasma delay”:* no free parameters and only the electrostatic e-h interactions in the ionization wake are considered.

*Many complications for the numerical implementation: huge number of involved elementary carriers (electrons and holes)...*



*Plasma effects in the ionization wake and  
Coulomb self-field (Bardelli et al – in preparation)*





PSA on charge signals: exp & sim

Silicon Rear injection  
Digital Pulse Shape  
experiment and simulation  
Experiment → *L. Bardelli et al: NP A746 (2004) 272*

Increase simulated and experimental data base  
Find the best algorithms for Pulse shape analysis  
Test timing for reverse-mount Silicon  
Test channeling effects for higher Z

*L. Bardelli et al*

Time = 3.1 ns

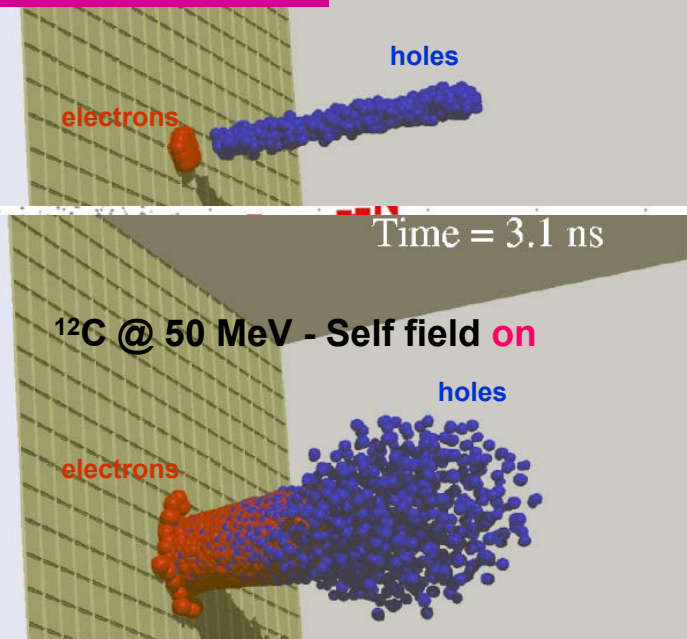
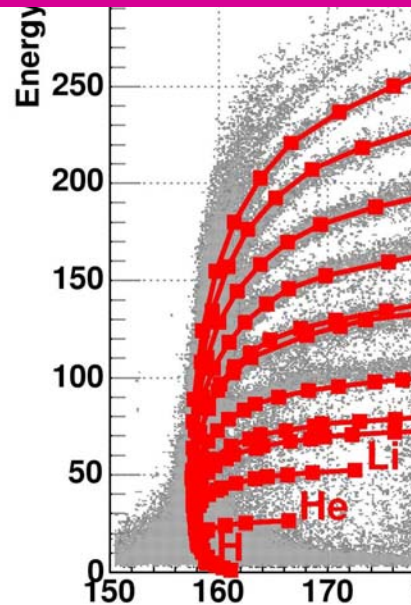
self field **off**

Silicon Front  
Digital Pulse Shape  
experiment and  
simulation

Experiment: Chimera Coll.  
LNS Report 2004, 129

Simulation: → *L. Bardelli et al in preparation*

*Tuning is under way to control numerical instabilities for higher Z ions*



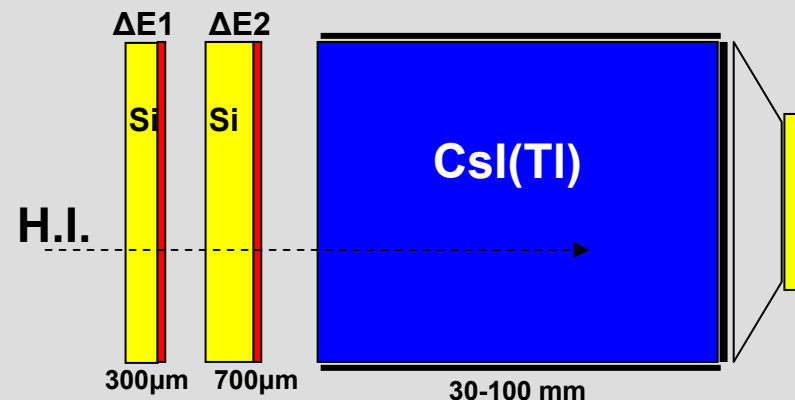
### Detector and front end electronics:

#### Three stage $\Delta E$ - $\Delta E$ -E (Si-Si-CsI telescope)

- Pulse Shape Analysis in the first reverse-mount *nTD* Silicon detector to extract Z and A with low thresholds, also exploiting ToF
- a Silicon pair of 300 $\mu\text{m}$  + 500-700  $\mu\text{m}$  for high-resolution standard A and Z identification
- a few cm thick CsI(Tl) for stopping more penetrating particles
- with a possible novel solution for the second  $\Delta E$ -E stage
- Charge-and-Current preamplifier (PACI) for improving pulse shape analysis

### Back-end electronics:

- Fully Digital Electronics for on-line signal treatment



### HOT ITEMS

- *Pulse Shape Analysis in nTD Silicon*
- *Why digital electronics?*
- *Charge/Current Preamp + Analogue Pipeline*
- *The Digital Single Chip Telescope*

# FAZIA: PROTOTYPING A NEXT-GENERATION 4π DETECTION ARRAY

## Why digital electronics?

Once you have good control of the hardware and of the Digital Signal Processing techniques *and you can write your own DSP software, why not?*

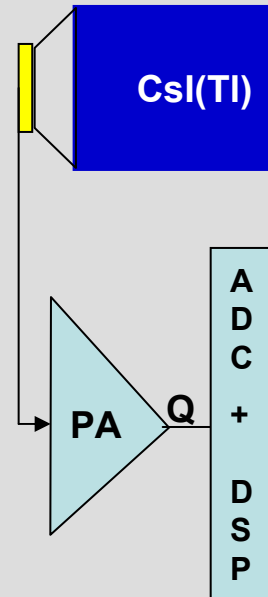
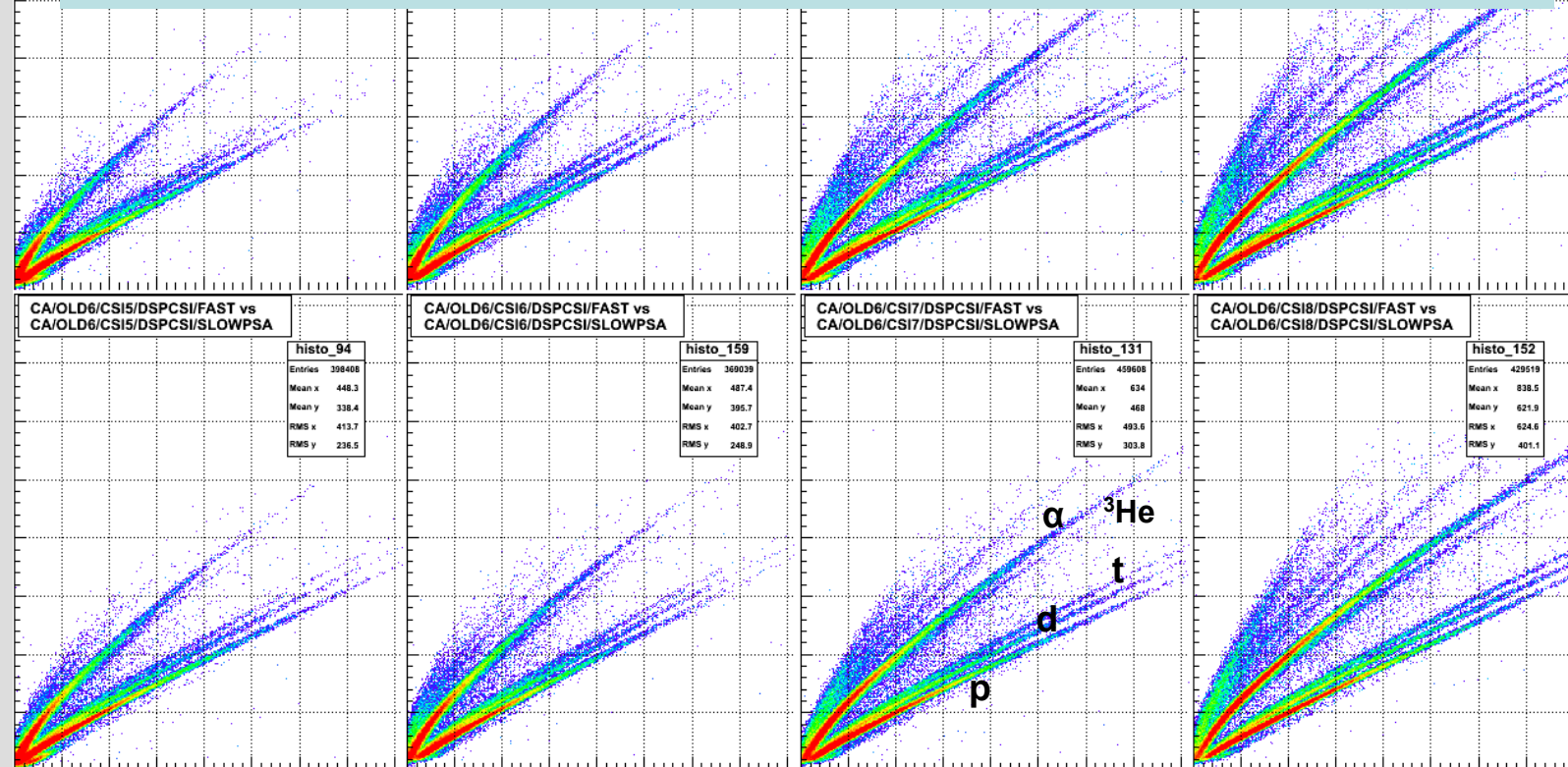
*Fully home-implemented solutions permit a sizeable cost reduction (at least a factor of 10)*

*A few examples demonstrate that charge-particle detectors can strongly profit from those techniques (fully home-implemented)*

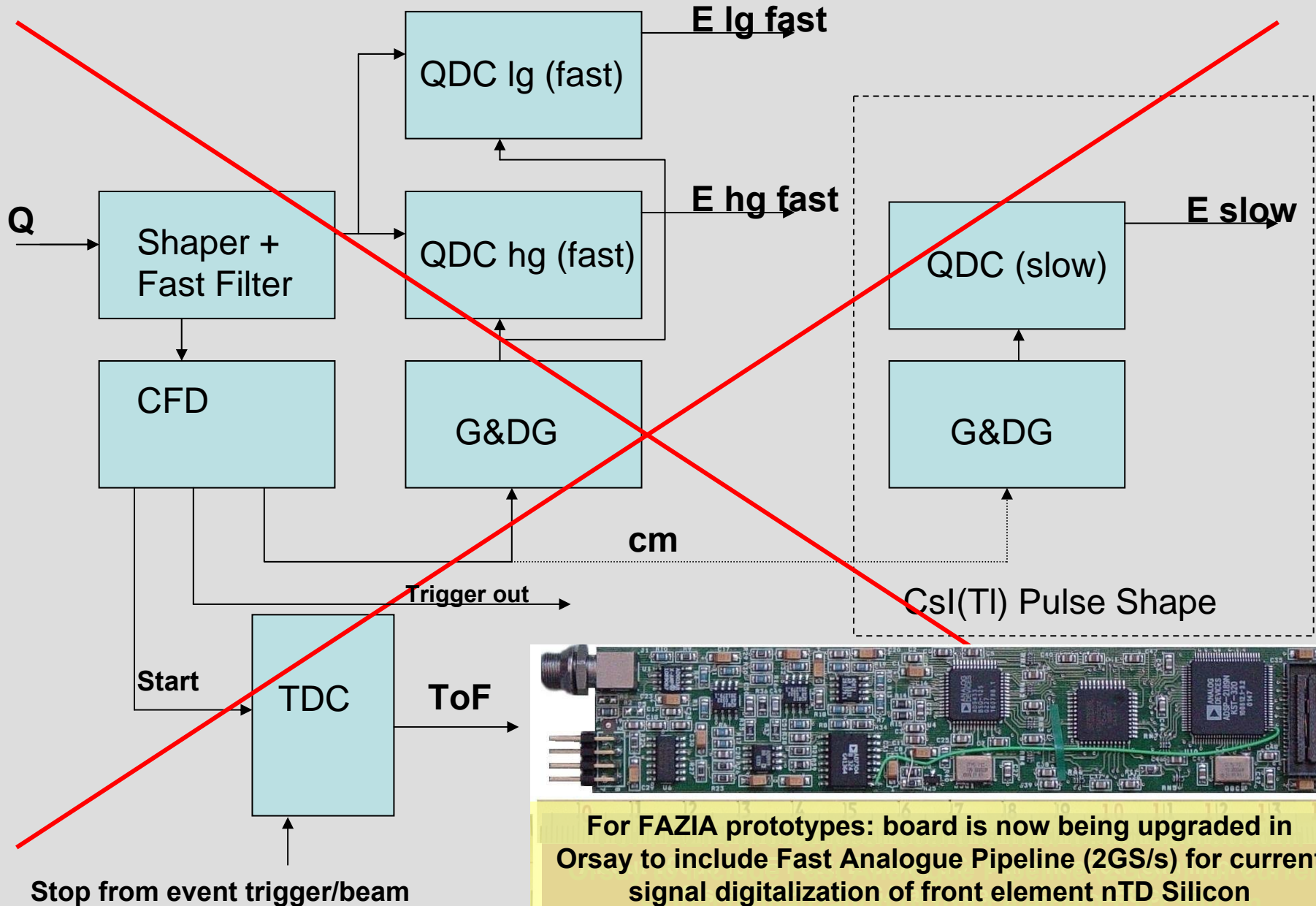
ur

eam - LNL:

@ 15AMeV

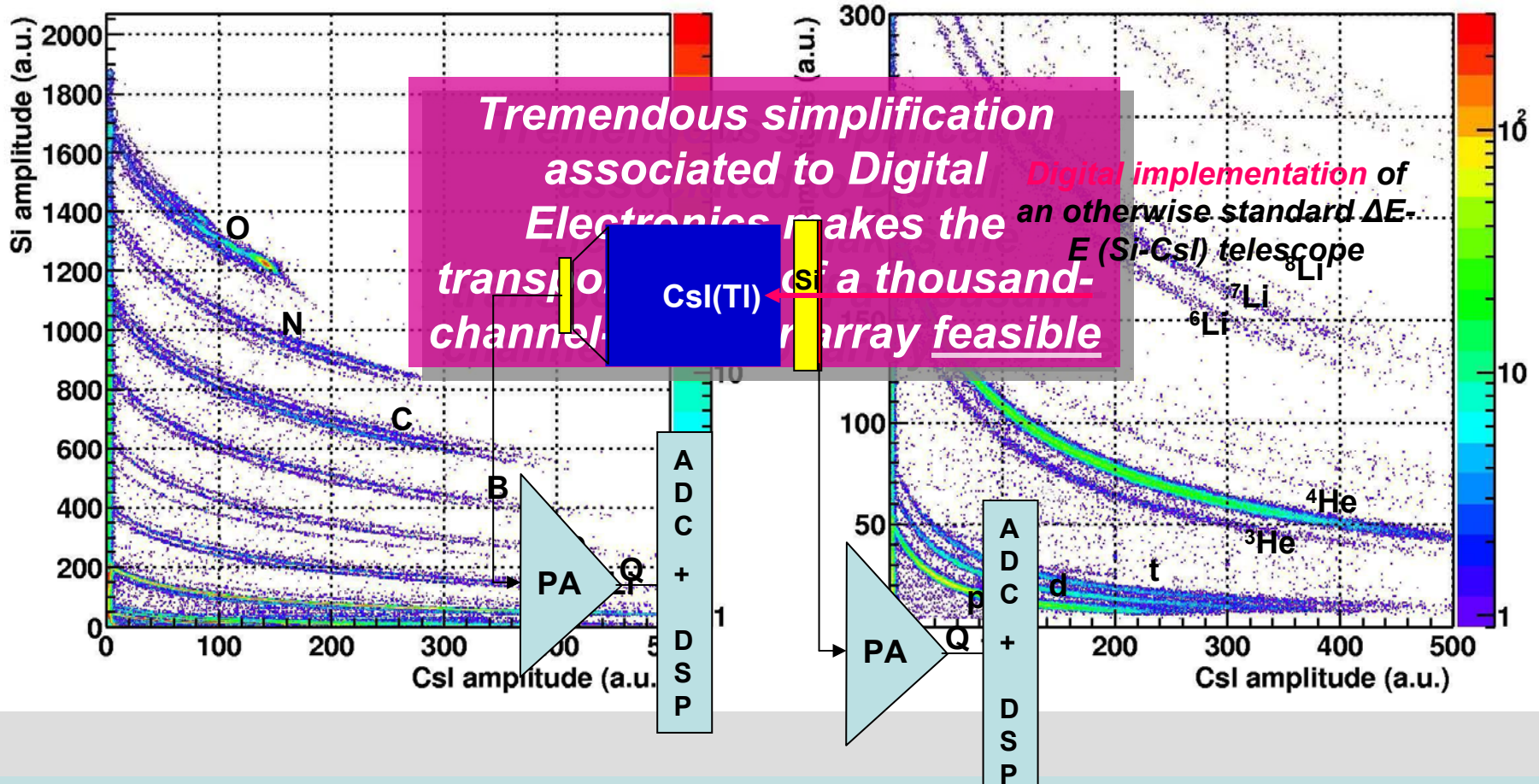


# What a fast ADC + (well programmed) DSP/FPGA can replace



ΔE-E correlation from digitized data

Digitized data: expanded view



**Tremendous simplification associated to Digital Electronics makes the transition of a thousand-channel array feasible**

**Digital implementation of an otherwise standard ΔE-E (Si-CsI) telescope**

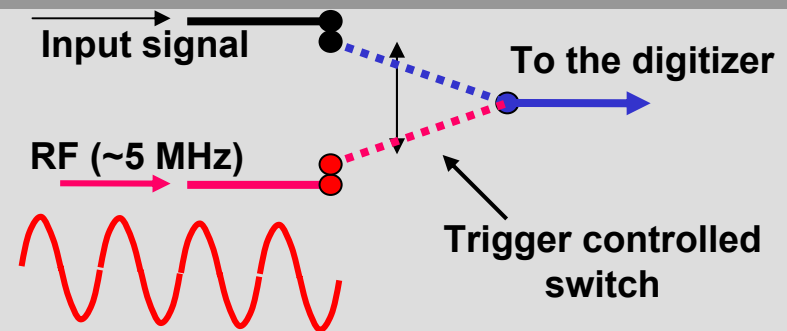
“Bit gain” effect: a digital chain based on a **12 bit sampling ADC at 100 MSample/s** provides amplitude measurements with the same dynamic ranges of an analogue chain with a final **16 bit ADC** (typically implemented with the two-gain approach)

For a quantitative explanation, see **2x(L. Bardelli and G.P. , NIMA 560 (2006))**

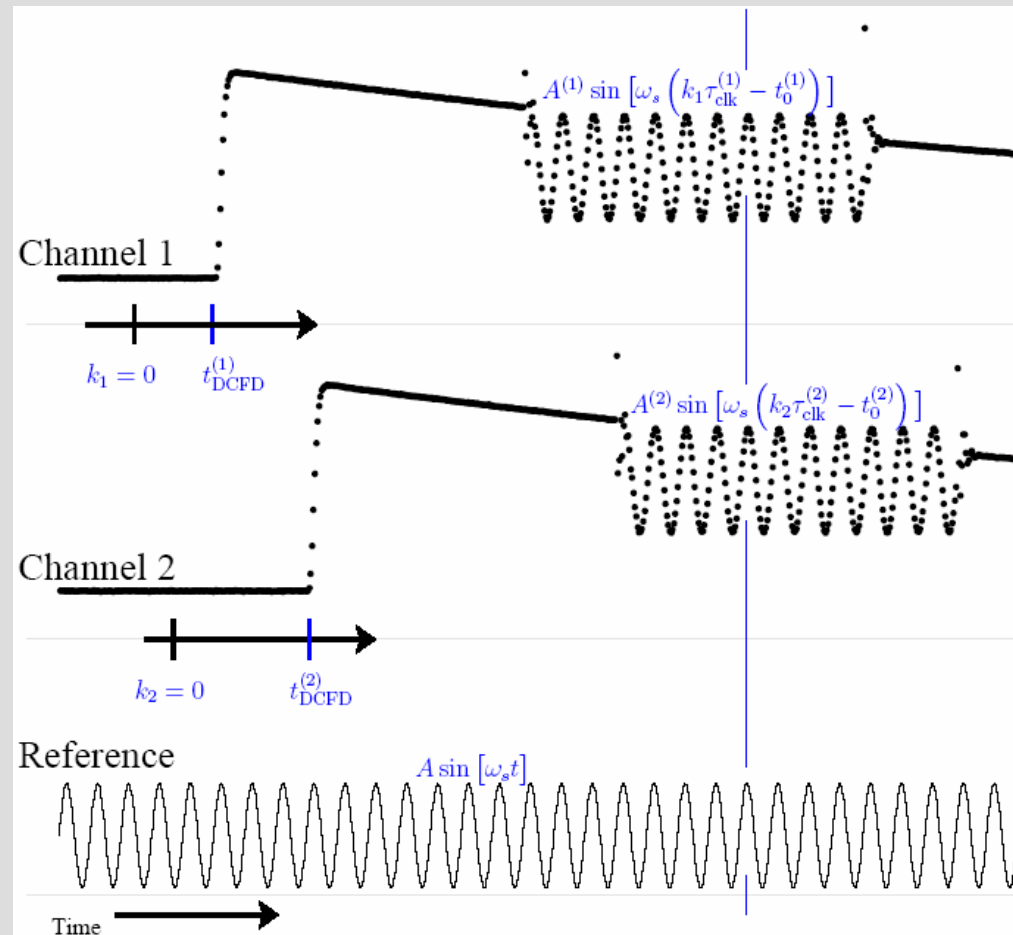
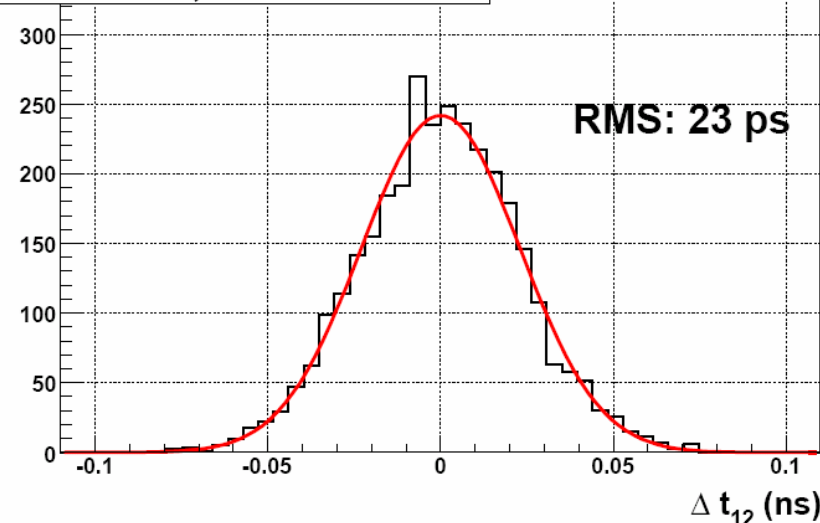
## Digital ToF and synchronization:

- easy operation and upgrading suggest independently clocked digitizers
- how to synchronize them (*at a-few-tens-of-ps level*)?

For trigger-based arrays a solution has been proposed (*L. Bardelli et al: NIM A521 (2004) 480 and submitted to NIM*)



Coinc. test, 125 MS/s ADCs



For Silicon detectors, by sampling with 100-200 MS/s @ 12-14 bits: **“detector-limited” timing**

Dynamic ranges for **digital timing** are expected to be similar to **analogue** implementation: **minor “bit gain” effect**

# FAZIA: PROTOTYPING A NEXT-GENERATION $4\pi$ DETECTION ARRAY

## Some envisaged solutions for the prototypes

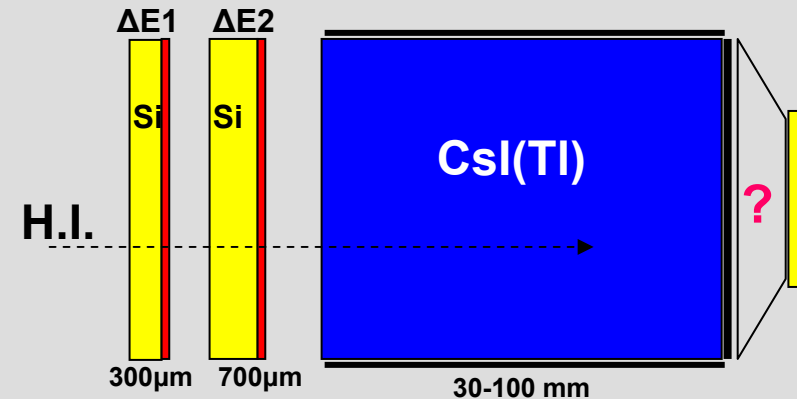
### Detector and front end electronics:

#### Three stage $\Delta E$ - $\Delta E$ -E (Si-Si-CsI telescope)

- Pulse Shape Analysis in the first reverse-mount *nTD* Silicon detector to extract Z and A with low thresholds, also exploiting ToF
- a Silicon pair of  $300\mu\text{m} + 500\text{-}700\mu\text{m}$  for high-resolution standard A and Z identification
- a few cm thick CsI(Tl) for stopping more penetrating particles
- with a possible novel solution for the second  $\Delta E$ -E stage
- Charge-and-Current preamplifier (PACI) for improving pulse shape analysis

### Back-end electronics:

- Fully Digital Electronics for on-line signal treatment



### HOT ITEMS

- *Pulse Shape Analysis in nTD Silicon*
- *Why digital electronics*
- *Charge/Current Preamp + Analogue Pipeline*
- *The Digital Single Chip Telescope*

# The Single Chip Telescope (SCT)

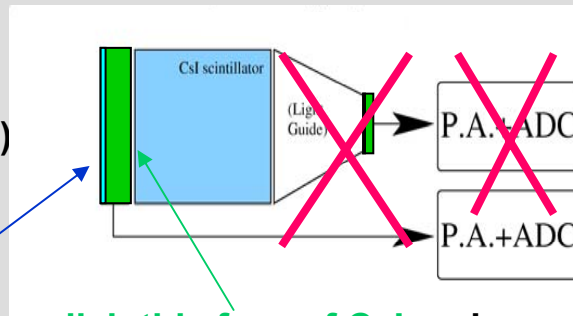
A novel, revisited telescope:  
"Single Chip Telescope"

(G.Pasquali et al: NIM A301 (1991) 101)  
(L.Bardelli et al: NP A746 (2004) 272)

The Si-CsI(Tl) SCT telescope



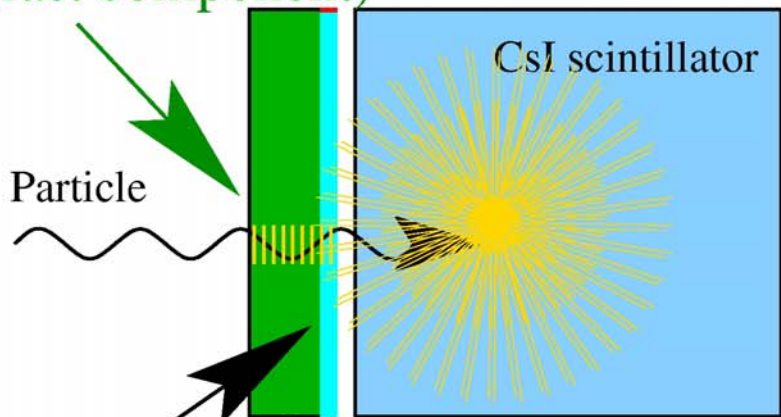
Standard Si-CsI(Tl)  
telescope configuration



Let's flip Silicon, polish this face of CsI and  
throw away light guide and photodiode

**Ionization**  
(fast component)

Reverse mount Silicon Detector



Current signal (fast + slow)

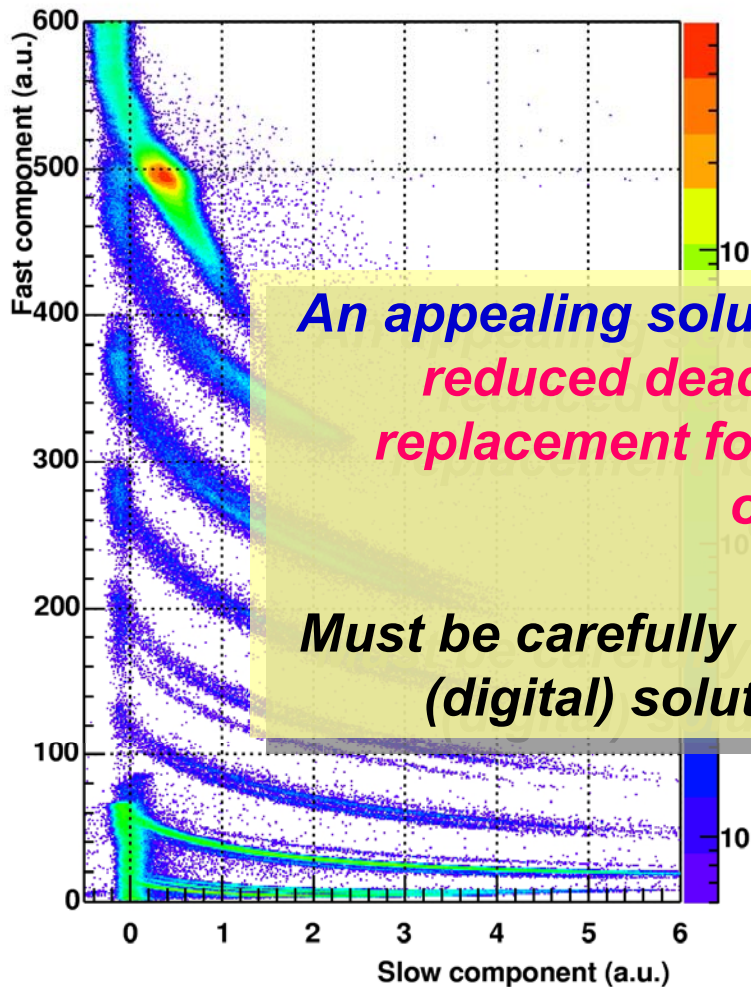
Collected  
Light  
(slow component)

Photosensitive  
front surface

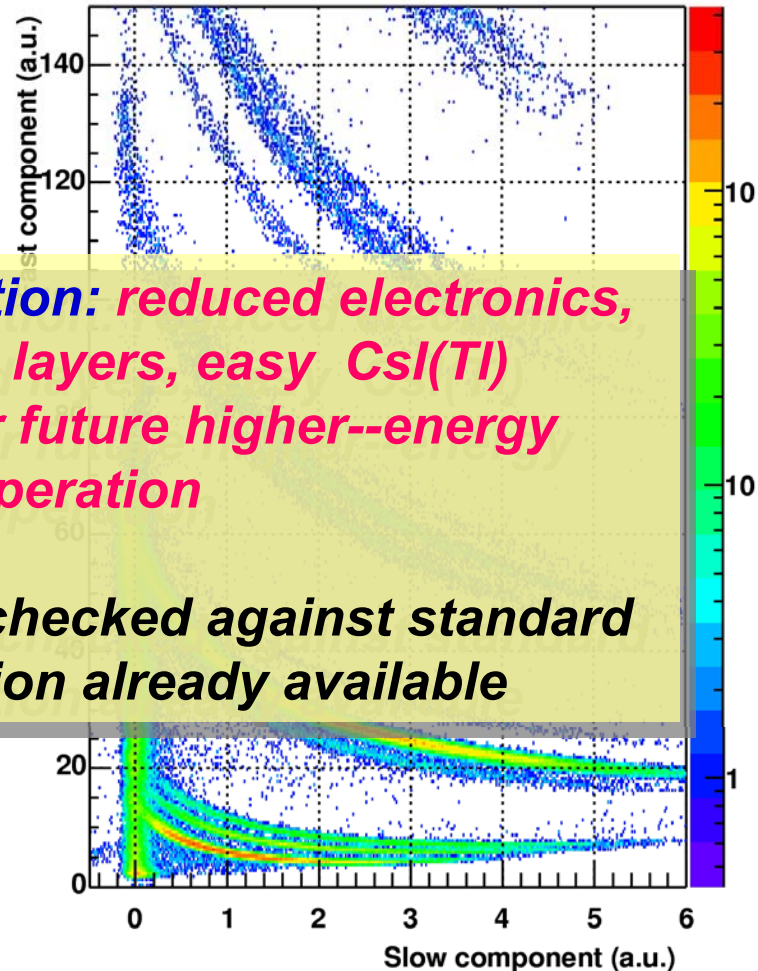
P.A.+ADC

# Fully digitized Single Chip Telescope

SCT digital Fast vs. Slow



SCT digital Fast vs. Slow (expanded)



*An appealing solution: reduced electronics,  
reduced dead layers, easy CsI(Tl)  
replacement for future higher--energy  
operation*

*Must be carefully checked against standard  
(digital) solution already available*

**RNB6**

*L.Bardelli et  
al: NP A746  
(2004) 272*

**The three FAZIA phases**

**Phase I (*the present up to 2008*):**

- Elaborate Physics cases to better pin down the final detector characteristics
- Test envisaged solutions and build prototypes
- Build a Prototype array to test “*under beam*” realistic conditions

**Phase II (*if Phase I passed, from 2008 till 2011*):**

- build a Demonstrator, to couple with existing arrays and do Physics out of it

**Phase III (*from 2011 and up*):**

- Build the  $4\pi$  Array

**Financial support for Phase I (a MoU is in preparation):**

- France: ANR + IN2P3
- Italy: INFN and (possibly) from the Ministry of University and Research
- other participating countries submit requests to national funding agencies
- total support for the three-years R&D of the order of 1.5 M€, including Prototype Array

# FAZIA: presently involved Institutions and physicists (+ an almost equal amount of engineers/technicians)

## FRANCE:

- INPO (Orsay): B.Borderie
- GANIL: A.Chibhi, J.Fran
- LPC (Caen): R.Bougault,
- IPNL (Lyon): P.Lautesse,

## ITALY:

- Bologna (INFN & Univers
- Firenze (INFN & Univers
- Catania (INFN): M.Baldo,
- LNL (INFN): F.Gramegna,
- Napoli (INFN & Universi
- LNS: R.Alba\*, A.Bonase

## SPAIN:

- Huelva: R.Berijillos, J.L.F
- Sevilla: (HIDE collaborati

## Eastern Europe:

- Cracow + Katowice: Tom
- Warsaw: A.Kordyasz + ...
- Bucarest: R.Borcea, A.Eu

## CANADA:

- University of Laval – Queb

## US:

- Western Michigan University: M.Famiano

## INDIA

## FAZIA : *Four $\pi$ A-Z Identification Array*

Scientific Coordinator: *G.P.*



Scientific Deputy Coordinator: *R.Bougault*

Technical Coordinator: *P.Edelbruck*



Active working groups and convernors:

**Signal Shape Analysis...** (*L.Bardelli*)

**Physics cases** (*G.Verde*)

**Preamplifier & front-end...** (*P.Edelbruck*)

**Acquisition** (*B.Carniol*)

**Semiconductor detectors...** (*L.Lavergne*)

**Csl detectors** (*M.Parlog*)

**Single Chip Telescope** (*G.P.*)

**Detector Design and Integration** (*R.Bougault & M.Bruno*)

**Web site** (*O.Lopez*)

**Recent non-scientific events are now severely jeopardizing the FAZIA collaboration, in particular the relationship between the two largest parties/teams: France and Italy....**